## LNJ210C62RA

### Hight Bright Surface Mounting Chip LED

Side View Type

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Symbol Rating	
Power dissipation	$P_{\mathrm{D}}$	55	mW
Forward current	$I_{\mathrm{F}}$	20	mA
Pulse forward current *	I <sub>FP</sub>	60	mA
Reverse voltage	V <sub>R</sub>	4	V
Operating ambient temperature	T <sub>opr</sub>	-25 to +80	°C
Storage temperature	T <sub>stg</sub>	-30 to +85	°C

Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

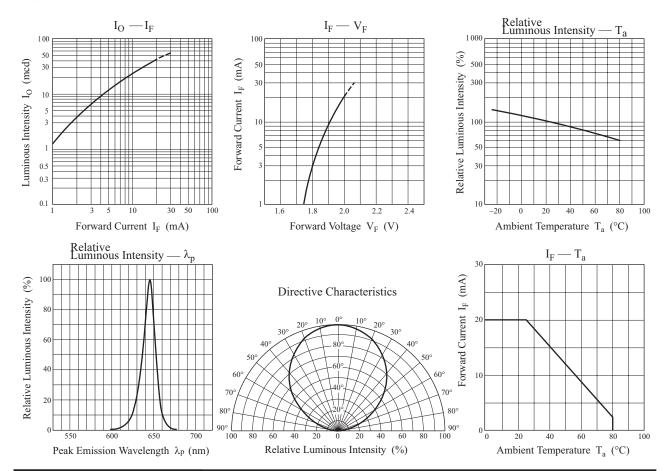
#### ■ Lighting Color

• Red

#### ■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

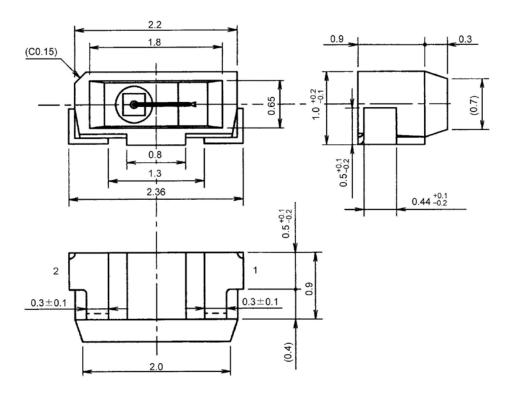
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I <sub>O</sub>	$I_F = 10 \text{ mA}$	12	23		mcd
Reverse current	$I_R$	$V_R = 4 V$	12		100	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$		1.92	2.50	V
Peak emission wavelength	$\lambda_{\mathrm{P}}$	$I_F = 10 \text{ mA}$		645		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		15		nm

Note) \*: Measurement tolerance: ±20%



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### ■ Package (Unit: mm)



- Pin name
  - 1: Anode
  - 2: Cathode

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